

Pb Free Plating Product

30CPH03



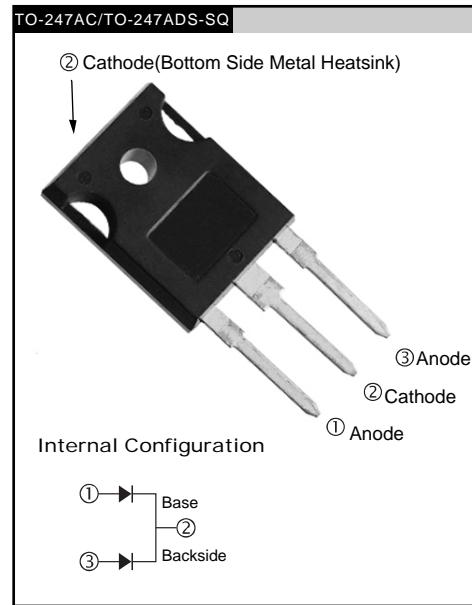
30Ampere,300Volt Dual Common Cathode Hyperfast Recovery Rectifier Diode

APPLICATION

- Freewheeling, Snubber, Clamp
- Inversion Welder
- PFC
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- UPS

PRODUCT FEATURE

- Ultrafast Recovery Time
- Soft Recovery Characteristics
- Low Recovery Loss
- Low Forward Voltage
- High Surge Current Capability
- Low Leakage Current

**GENERAL DESCRIPTION**

30CPH03 using ThinkiSemi FRED FAB process(planar passivation pellet) with hyperfast and soft recovery characteristics.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Repetitive peak reverse voltage	V_{RRM}			300	V
Average rectified forward current per leg total device	$I_{F(AV)}$	$T_C = 142^\circ C$	15	A	
			30		
Non-repetitive peak surge current per leg	I_{FSM}	$T_J = 25^\circ C, t_p = 10 \text{ ms}$	140		
Operating junction and storage temperatures	T_J, T_{Stg}			-65 to +175	°C

ELECTRICAL SPECIFICATIONS ($T_J = 25^\circ C$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V_{BR}, V_R	$I_R = 100 \mu A$	300	-	-	V
Forward voltage	V_F	$I_F = 15 A$	-	1.05	1.25	
		$I_F = 15 A, T_J = 125^\circ C$	-	0.85	1.00	
Reverse leakage current	I_R	$V_R = V_R \text{ rated}$	-	0.05	40	μA
		$T_J = 125^\circ C, V_R = V_R \text{ rated}$	-	12	400	
Junction capacitance	C_T	$V_R = 300 V$	-	45	-	pF
Series inductance	L_S	Measured lead to lead 5 mm from package body	-	8	-	nH

DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t_{rr}	$I_F = 1.0 \text{ A}$, $dI_F/dt = 50 \text{ A}/\mu\text{s}$, $V_R = 30 \text{ V}$		-	-	40	ns
		$T_J = 25^\circ\text{C}$		-	32	-	
		$T_J = 125^\circ\text{C}$		-	45	-	
Peak recovery current	I_{RRM}	$I_F = 15 \text{ A}$		-	2.4	-	A
		$dI_F/dt = -200 \text{ A}/\mu\text{s}$		-	6.1	-	
		$V_R = 200 \text{ V}$		-	38	-	
Reverse recovery charge	Q_{rr}	$T_J = 25^\circ\text{C}$		-	137	-	nC
		$T_J = 125^\circ\text{C}$		-			

THERMAL - MECHANICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T_J, T_{Stg}		-65	-	175	°C
Thermal resistance, junction to case per leg	R_{thJC}		-	0.9	2.0	°C/W
Thermal resistance, junction to ambient per leg	R_{thJA}	Typical socket mount	-	-	40	
Thermal resistance, case to heatsink	R_{thCS}	Mounting surface, flat, smooth, and greased	-	0.4	-	
Weight			-	6.0	-	g
			-	0.21	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style TO-247AC/TO-247ADS-SQ	30CPH03			

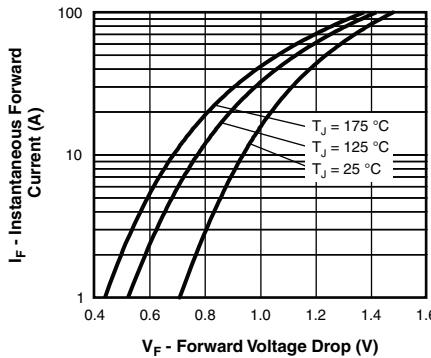


Fig. 1 - Typical Forward Voltage Drop Characteristics

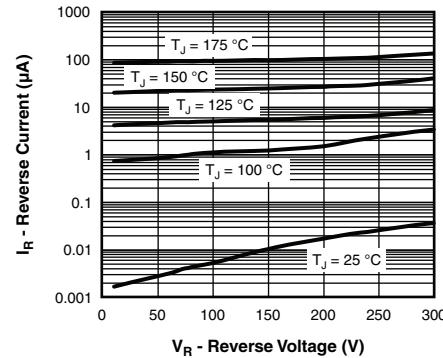


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

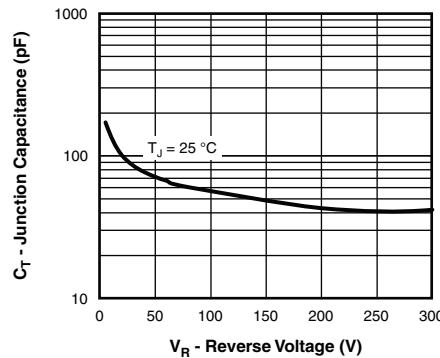
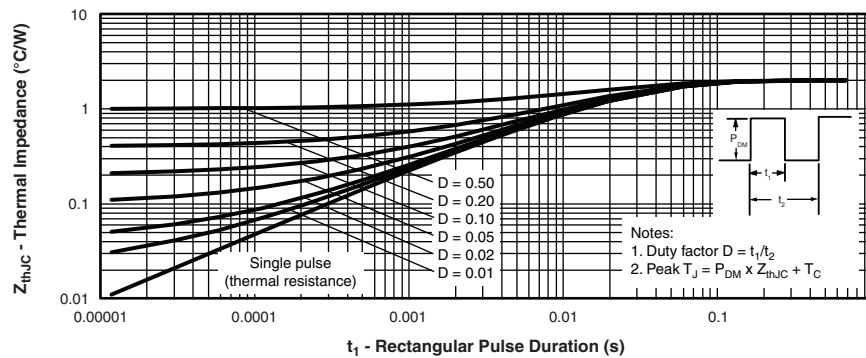


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

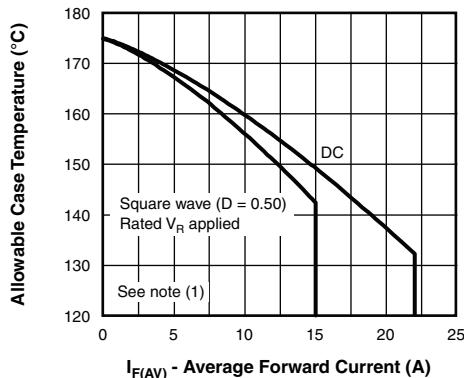


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

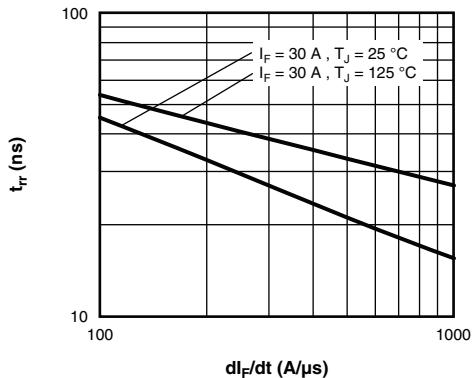


Fig. 7 - Typical Reverse Recovery Time vs. dI_F/dt

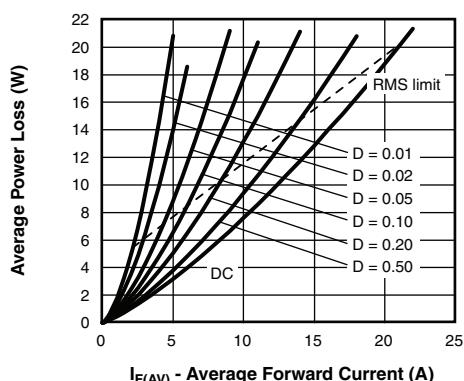


Fig. 6 - Forward Power Loss Characteristics

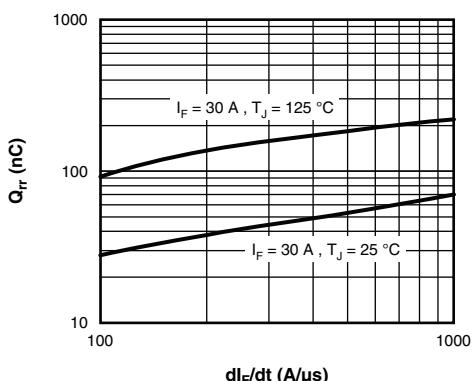


Fig. 8 - Typical Stored Charge vs. dI_F/dt

Note

- (1) Formula used: $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$;
 P_d = forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
 P_{dREV} = inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = rated V_R

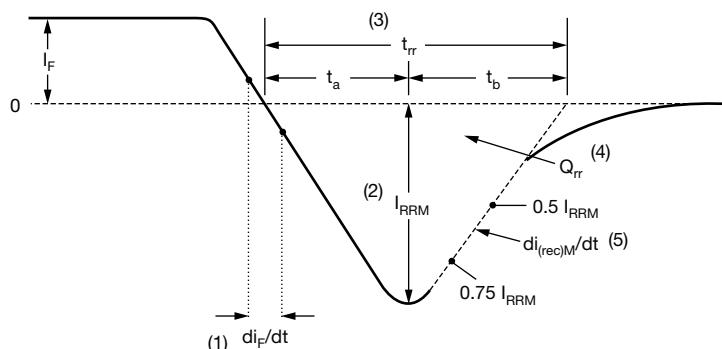
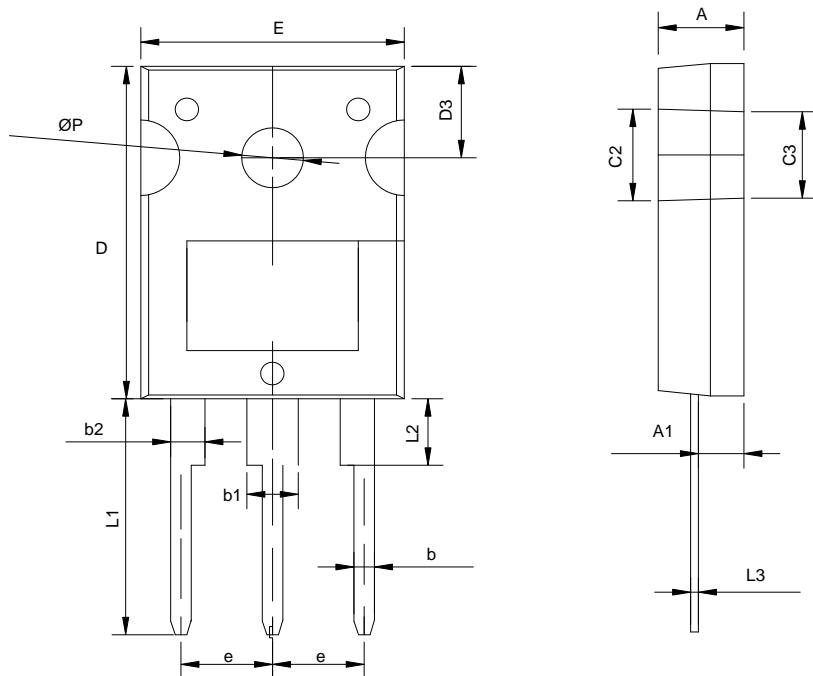


Fig. 9 - Reverse Recovery Waveform and Definitions

THINKI TO-247AC/TO-247ADS-SQ package outline



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.30	2.50	2.70
b	1.10	1.20	1.30
b1	2.90	3.10	3.30
b2	1.90	2.10	2.30
c2	5.50	6.00	6.50
c3	4.95	5.10	5.25
D	19.00	20.00	21.00
D3	5.30	5.50	5.70
e	5.34	5.44	5.54
E	15.40	15.60	15.80
L1	14.40	14.60	14.80
L2	3.85	4.00	4.15
L3	0.35	0.50	0.65
ØP	3.40	3.60	3.80